

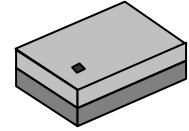
GNSS Front-End Module

■ GENERAL DESCRIPTION

The NJG1159PHH is a front-end module (FEM) designed for GNSS including GPS, GLONASS, BeiDou, and Galileo applications. This FEM offers low noise figure, high linearity, and high out-band rejection characteristics brought by included high performance pre-SAW filter and low noise amplifier (LNA). This FEM can operate from 1.5V to 3.3V single voltage in -40 to 105°C. This FEM has stand-by mode to save current consumption.

This FEM offers very small mounting area by included one SAW filter, only two external components, and very small package HFFP10-HH that is 1.5x1.1mm.

■ PACKAGE OUTLINE

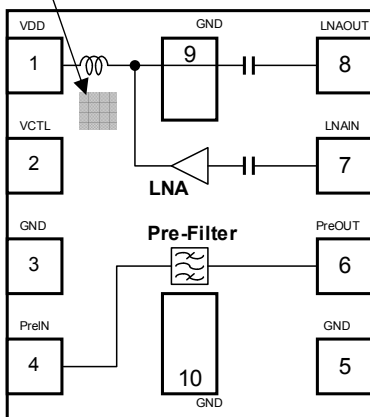


■ FEATURES

- Available for GNSS
 - Low supply voltage
 - Low current consumption
 - High gain
 - Low noise figure
 - High out band rejection
 - Small package size
 - RoHS compliant and Halogen Free, MSL1
- 1.8/ 2.8V typ.
 3.0/3.7mA typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=1.8V$
 0.1 μ A typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=0V$ (Stand-by mode)
 15.5/16.0dB typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=1.8V$,
 $f=1575MHz$, 1559 to 1591MHz
 1.55/1.50dB typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=1.8V$, $f=1575MHz$
 1.70/1.65dB typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=1.8V$, $f=1597$ to 1606MHz
 1.75/1.70dB typ. @ $V_{DD}=1.8/ 2.8V$, $V_{CTL}=1.8V$, $f=1559$ to 1591MHz
 55dBc typ. @ $f=704$ to 915MHz, relative to 1575MHz
 43dBc typ. @ $f=1710$ to 1980MHz, relative to 1575MHz
 51dBc typ. @ $f=2400$ to 2500MHz, relative to 1575MHz
 HFFP10-HH: 1.5mmx1.1mm (typ.), t=0.5mm (max.)

■ PIN CONFIGURATION

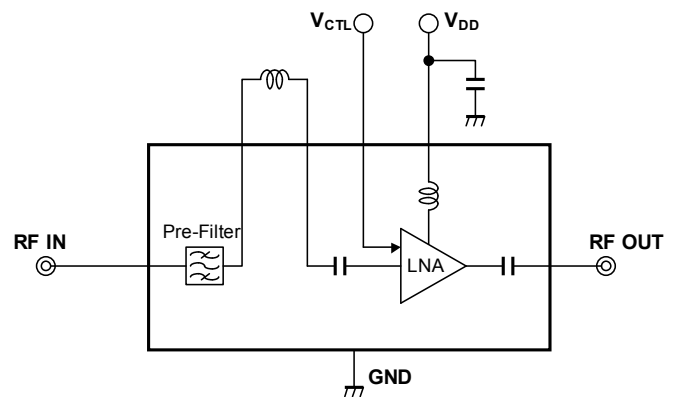
1 pin index (Top View)



Pin Connection

1. VDD
2. VCTL
3. GND
4. PreIN
5. GND
6. PreOUT
7. LNAIN
8. LNAOUT
9. GND
10. GND

■ BLOCK DIAGRAM



■ TRUTH TABLE

“H”= $V_{CTL}(H)$, “L”= $V_{CTL}(L)$

VCTL	Mode
H	Active mode
L	Stand-by mode

Note: Specifications and description listed in this datasheet are subject to change without notice.

■ ABSOLUTE MAXIMUM RATINGS

$T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$

PARAMETERS	SYMBOL	CONDITIONS	RATINGS	UNITS
Supply voltage	V_{DD}		5.0	V
Control voltage	V_{CTL}		5.0	V
Input power	P_{IN} (inband)	$V_{DD}=2.8\text{V}$, $f=1575, 1597$ to $1606, 1559$ to 1591MHz	10	dBm
	P_{IN} (outband)	$V_{DD}=2.8\text{V}$, $f=50$ to $1460, 1710$ to 4000MHz	25	dBm
Power dissipation	P_D	4-layer FR4 PCB without through-hole ($101.5 \times 114.5\text{mm}$), $T_j=110^{\circ}\text{C}$	560	mW
Operating temperature	T_{opr}		-40 to +105	$^{\circ}\text{C}$
Storage temperature	T_{stg}		-40 to +110	$^{\circ}\text{C}$

■ ELECTRICAL CHARACTERISTICS 1 (DC)

(General conditions: $T_a=+25^{\circ}\text{C}$)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V_{DD}		1.5	-	3.3	V
Control Voltage (High)	$V_{CTL(H)}$		1.5	1.8	3.3	V
Control Voltage (Low)	$V_{CTL(L)}$		0	0	0.3	V
Supply Current 1	I_{DD1}	RF OFF, $V_{DD}=2.8\text{V}$, $V_{CTL}=1.8\text{V}$	-	3.7	-	mA
Supply Current 2	I_{DD2}	RF OFF, $V_{DD}=1.8\text{V}$, $V_{CTL}=1.8\text{V}$	-	3.0	-	mA
Supply Current 3	I_{DD3}	RF OFF, $V_{DD}=2.8\text{V}$, $V_{CTL}=0\text{V}$	-	0.1	5.0	μA
Supply Current 4	I_{DD4}	RF OFF, $V_{DD}=1.8\text{V}$, $V_{CTL}=0\text{V}$	-	0.1	5.0	μA
Control Current	I_{CTL}	$V_{CTL}=1.8\text{V}$	-	5.0	15.0	μA

■ ELECTRICAL CHARACTERISTICS 2 (RF)

General conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{RF}=1575MHz$, 1597 to 1606, 1559 to 1591MHz,
 $T_a=+25^{\circ}C$, $Z_s=Z_l=50\Omega$, with application circuit

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Small Signal Gain (GPS)1	GainGPS1	f=1575MHz (GPS) Exclude PCB, Connector Losses (0.17dB)	-	16.0	-	dB
Small Signal Gain (GLONASS)1	GainGLN1	f=1597 to 1606MHz (GLONASS) Exclude PCB, Connector Losses (0.17dB)	-	16.5	-	dB
Small Signal Gain (BeiDou, Galileo)1	GainBG1	f=1559 to 1591MHz (BeiDou, Galileo) Exclude PCB, Connector Losses (0.17dB)	-	16.0	-	dB
Noise Figure (GPS)1	NFGPS1	f=1575MHz (GPS)Exclude PCB, Connector Losses (0.09dB)	-	1.50	-	dB
Noise Figure (GLONASS)1	NFGLN1	f=1597 to 1606MHz (GLONASS) Exclude PCB, Connector Losses (0.09dB)	-	1.65	-	dB
Noise Figure (BeiDou, Galileo)1	NFBG1	f=1559 to 1591MHz (BeiDou, Galileo) Exclude PCB, Connector Losses (0.09dB)	-	1.70	-	dB
Input Power at 1dB Gain Compression Point 1	P-1dB(IN)1	f=1575, 1597 to 1606, 1559 to 1591MHz	-	-10.0	-	dBm
Input 3rd Order Intercept Point 1	IIP3_1	f1=1575,1597 to 1606,1559 to 1591MHz, f2=f1 +/-1MHz, Pin=-30dBm	-	-2.0	-	dBm
Out of Band Input 2nd Order Intercept Point 1	IIP2_OB1	f1=824.6MHz at +15dBm, f2=2400MHz at +15dBm, fmeas=1575.4MHz	-	+80	-	dBm
Out of Band Input 3rd Order Intercept Point 1	IIP3_OB1	f1=1712.7MHz at +15dBm, f2=1850MHz at +15dBm, fmeas=1575.4MHz	-	+55	-	dBm
700MHz Harmonic 1	2fo1	Input jammer tone: 787.76MHz at +15dBm Measure the harmonic tone at 1575.52MHz	-	-37	-	dBm
Out-of-Band Input Power 1dB Compression 1	P-1dB(IN)_OB1-1	fjam=900MHz, fmeas=1575MHz at Pin=-40dBm	-	+24	-	dBm
	P-1dB(IN)_OB1-2	fjam=1710MHz, fmeas=1575MHz at Pin=-40dBm	-	+24	-	dBm
Low Band Rejection 1	BR_L1	f=704 to 915MHz, relative to 1575MHz	-	55	-	dBc
High Band Rejection 1	BR_H1	f=1710 to 1980MHz, relative to 1575MHz	-	43	-	dBc
WLAN Band Rejection 1	BR_W1	f=2400 to 2500MHz, relative to 1575MHz	-	51	-	dBc
RF IN Return Loss (GPS)1	RLiGPS1	f=1575MHz (GPS)	-	10	-	dB
RF IN Return Loss (GLONASS)1	RLiGLN1	f=1597 to 1606MHz (GLONASS)	-	15	-	dB
RF IN Return Loss (BeiDou, Galileo)1	RLiBG1	f=1559 to 1591MHz (BeiDou, Galileo)	-	13	-	dB
RF OUT Return Loss (GPS)1	RLoGPS1	f=1575MHz (GPS)	-	15	-	dB
RF OUT Return Loss (GLONASS)1	RLoGLN1	f=1597 to 1606MHz (GLONASS)	-	15	-	dB
RF OUT Return Loss (BeiDou, Galileo)1	RLoBG1	f=1559 to 1591MHz (BeiDou, Galileo)	-	15	-	dB
Group Delay Time Deviation (GLONASS) 1	GDTDGLN1	f=1597 to 1606MHz (GLONASS)	-	3	-	ns
Group Delay Time Deviation (BeiDou)1	GDTDB1	f=1559 to 1563.2MHz (BeiDou)	-	4	-	ns
Group Delay Time Deviation (Galileo)1	GDTDG1	f=1559 to 1591MHz (Galileo)	-	9	-	ns

■ ELECTRICAL CHARACTERISTICS 3 (RF)

General conditions: $V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{RF}=1575MHz$, 1597 to 1606, 1559 to 1591MHz,
 $T_a=+25^{\circ}C$, $Z_s=Z_l=50\Omega$, with application circuit

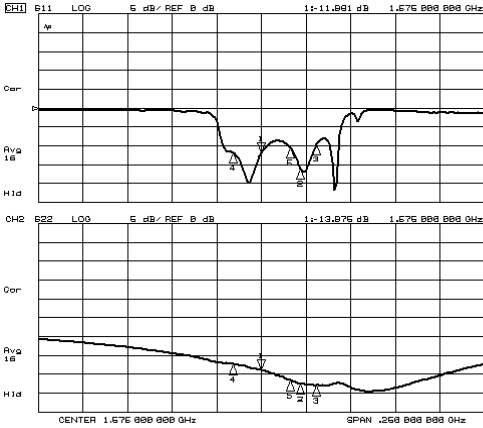
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Small Signal Gain (GPS) ₂	GainGPS2	f=1575MHz (GPS) Exclude PCB, Connector Losses (0.17dB)	-	15.5	-	dB
Small Signal Gain (GLONASS) ₂	GainGLN2	f=1597 to 1606MHz (GLONASS) Exclude PCB, Connector Losses (0.17dB)	-	16.0	-	dB
Small Signal Gain (BeiDou, Galileo) ₂	GainBG2	f=1559 to 1591MHz (BeiDou, Galileo) Exclude PCB, Connector Losses (0.17dB)	-	15.5	-	dB
Noise Figure (GPS) ₂	NFGPS2	f=1575MHz (GPS)Exclude PCB, Connector Losses (0.09dB)	-	1.55	-	dB
Noise Figure (GLONASS) ₂	NFGLN2	f=1597 to 1606MHz (GLONASS) Exclude PCB, Connector Losses (0.09dB)	-	1.70	-	dB
Noise Figure (BeiDou, Galileo) ₂	NFBG2	f=1559 to 1591MHz (BeiDou, Galileo) Exclude PCB, Connector Losses (0.09dB)	-	1.75	-	dB
Input Power at 1dB Gain Compression Point 2	P-1dB(IN) ₂	f=1575, 1597 to 1606, 1559 to 1591MHz	-	-13.0	-	dBm
Input 3rd Order Intercept Point 2	IIP3_2	f1=1575, 1597 to 1606, 1559 to 1591MHz, f2=f1 +/-1MHz, Pin=-30dBm	-	-5.0	-	dBm
Out of Band Input 2nd Order Intercept Point 2	IIP2_OB2	f1=824.6MHz at +15dBm, f2=2400MHz at +15dBm, fmeas=1575.4MHz	-	+80	-	dBm
Out of Band Input 3rd Order Intercept Point 2	IIP3_OB2	f1=1712.7MHz at +15dBm, f2=1850MHz at +15dBm, fmeas=1575.4MHz	-	+55	-	dBm
700MHz Harmonic ₂	2fo ₂	Input jammer tone: 787.76MHz at +15dBm Measure the harmonic tone at 1575.52MHz	-	-37	-	dBm
Out-of-Band Input Power 1dB Compression 2	P-1dB(IN)_OB2-1	fjam=900MHz, fmeas=1575MHz at Pin=-40dBm	-	+24	-	dBm
	P-1dB(IN)_OB2-2	fjam=1710MHz, fmeas=1575MHz at Pin=-40dBm	-	+24	-	dBm
Low Band Rejection 2	BR_L2	f=704 to 915MHz, relative to 1575MHz	-	55	-	dBc
High Band Rejection 2	BR_H2	f=1710 to 1980MHz, relative to 1575MHz	-	43	-	dBc
WLAN Band Rejection 2	BR_W2	f=2400 to 2500MHz, relative to 1575MHz	-	51	-	dBc
RF IN Return Loss (GPS) ₂	RLiGPS2	f=1575MHz (GPS)	-	10	-	dB
RF IN Return Loss (GLONASS) ₂	RLiGLN2	f=1597 to 1606MHz (GLONASS)	-	15	-	dB
RF IN Return Loss (BeiDou, Galileo) ₂	RLiBG2	f=1559 to 1591MHz (BeiDou, Galileo)	-	13	-	dB
RF OUT Return Loss (GPS) ₂	RLoGPS2	f=1575MHz (GPS)	-	15	-	dB
RF OUT Return Loss (GLONASS) ₂	RLoGLN2	f=1597 to 1606MHz (GLONASS)	-	15	-	dB
RF OUT Return Loss (BeiDou, Galileo) ₂	RLoBG2	f=1559 to 1591MHz (BeiDou, Galileo)	-	15	-	dB
Group Delay Time Deviation (GLONASS) ₂	GDTDGLN2	f=1597 to 1606MHz (GLONASS)	-	3	-	ns
Group Delay Time Deviation (BeiDou) ₂	GDTDB2	f=1559 to 1563.2MHz (BeiDou)	-	4	-	ns
Group Delay Time Deviation (Galileo) ₂	GDTDG2	f=1559 to 1591MHz (Galileo)	-	9	-	ns

■ TERMINAL INFORMATION

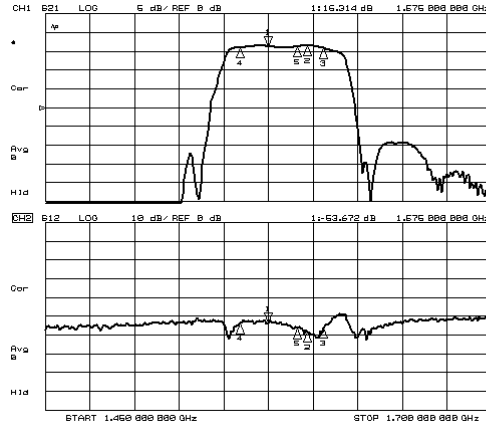
No.	SYMBOL	DESCRIPTION
1	VDD	Supply voltage terminal. Please connect bypass capacitor C1 with ground as close as possible.
2	VCTL	Control voltage terminal.
3	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
4	PreIN	RF input terminal. This terminal connects to input of pre-SAW filter.
5	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
6	PreOUT	Pre-SAW filter output terminal. This terminal connects to LNAIN with L1.
7	LNAIN	RF input terminal. This terminal requires only a matching inductor L1, and does not require DC blocking capacitor because of integrated capacitor.
8	LNAOUT	RF output terminal. This terminal requires no DC blocking capacitor since this terminal has integrated DC blocking capacitor.
9	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
10	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.

ELECTRICAL CHARACTERISTICS

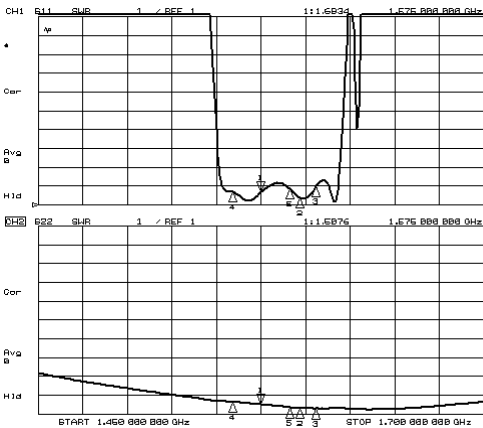
Conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $T_a=25^{\circ}C$, $Z_S=Z_I=50\Omega$, with application circuit



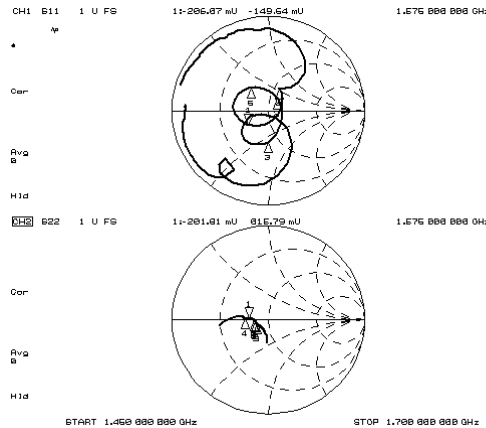
S11, S22



S21, S12



VSWR



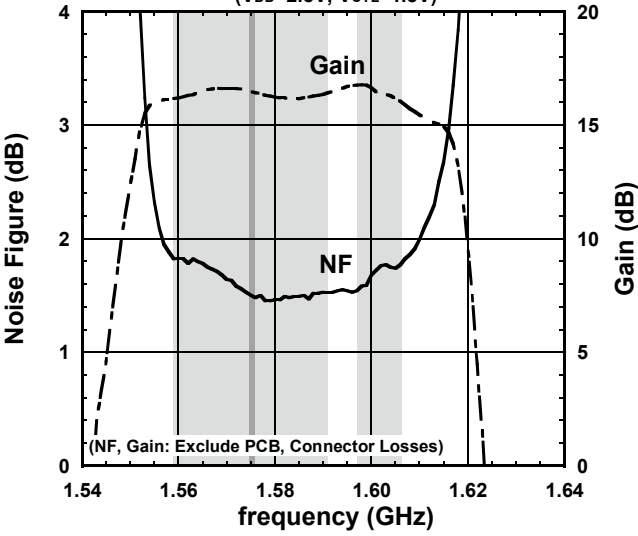
Zin, Zout

ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $T_a=25^\circ C$, $Z_s=Z_l=50\Omega$, with application circuit

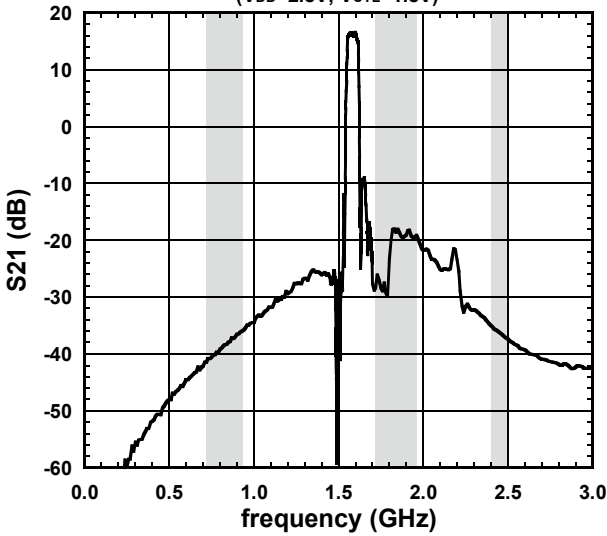
NF, Gain vs. frequency

($V_{DD}=2.8V$, $V_{CTL}=1.8V$)



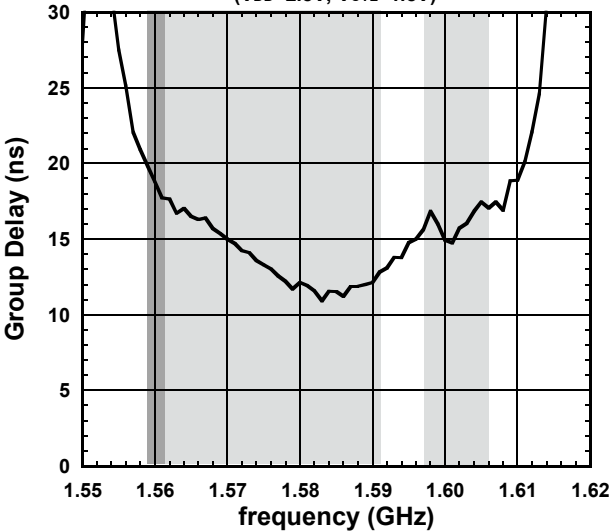
S21 vs. frequency

($V_{DD}=2.8V$, $V_{CTL}=1.8V$)



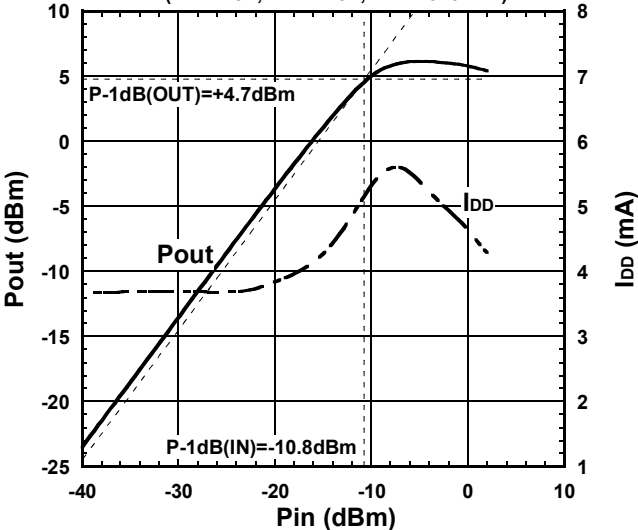
Group Delay vs. frequency

($V_{DD}=2.8V$, $V_{CTL}=1.8V$)



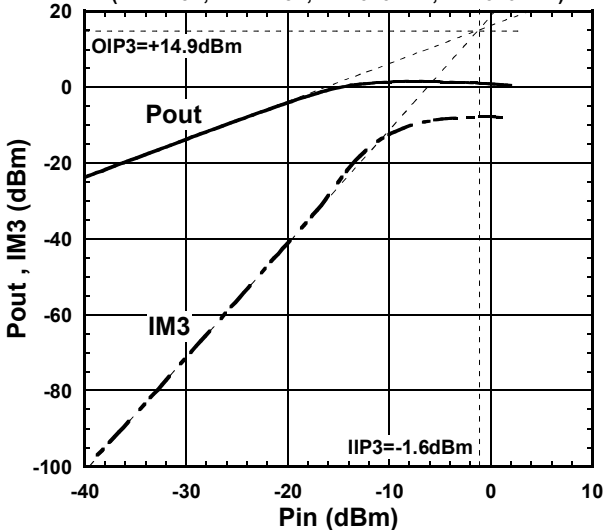
Pout, I_{DD} vs. Pin

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{RF}=1575MHz$)



Pout, IM3 vs. Pin

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_1=1575MHz$, $f_2=1576MHz$)

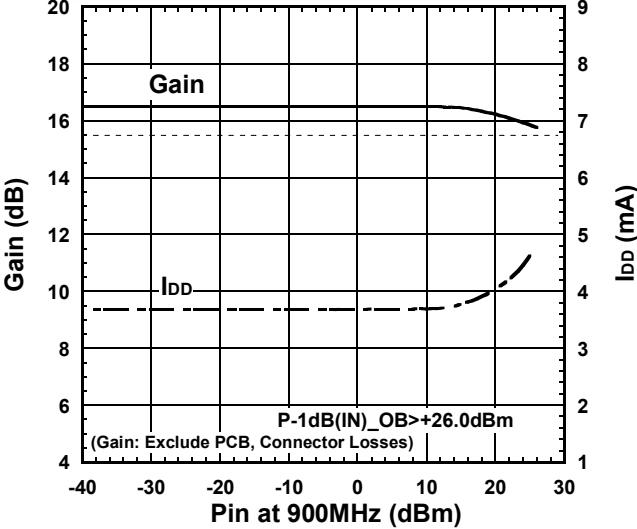


ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $T_a=25^\circ C$, $Z_s=Z_l=50\Omega$, with application circuit

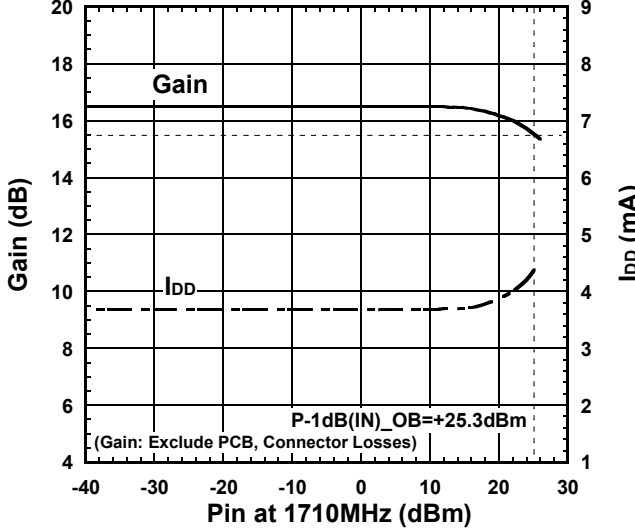
Out-of-band P-1dB (fjam=900MHz)

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575MHz$ at $Pin=-40dBm$)



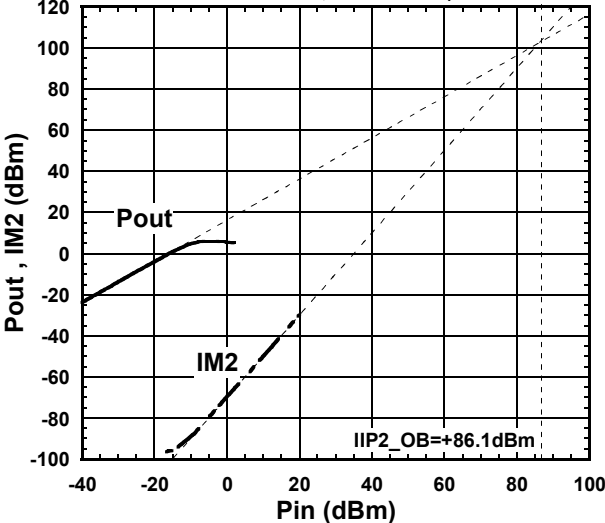
Out-of-band P-1dB (fjam=1710MHz)

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575MHz$ at $Pin=-40dBm$)



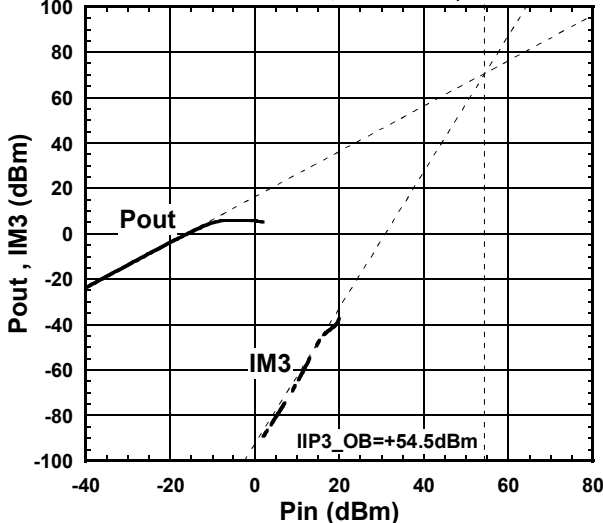
Out-of-band IIP2

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575.4MHz$, $f_1=824.6MHz$, $f_2=2400MHz$)



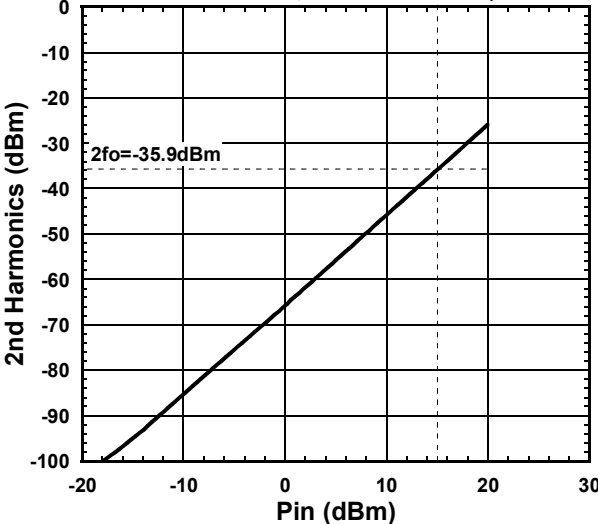
Out-of-band IIP3

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575.4MHz$, $f_1=1712.7MHz$, $f_2=1850MHz$)



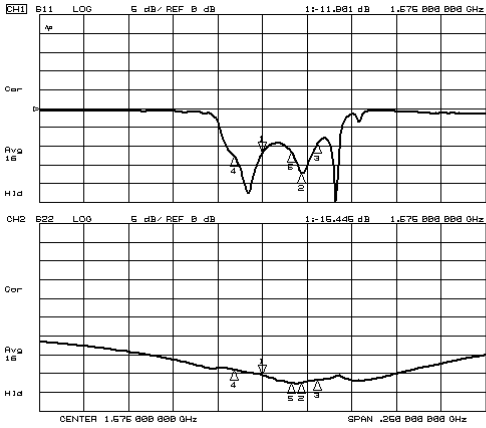
2nd Harmonics

($V_{DD}=2.8V$, $V_{CTL}=1.8V$, $f_{in}=787.76MHz$, $f_{meas}=1575.52MHz$)

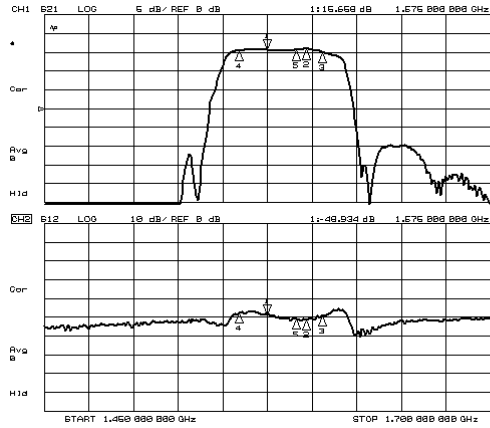


ELECTRICAL CHARACTERISTICS

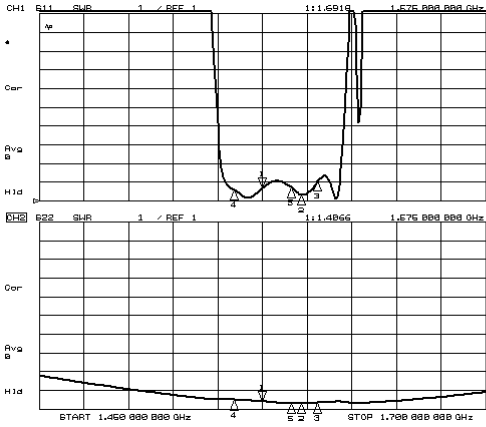
Conditions: $V_{DD}=1.8V$, $V_{CTL}=1.8V$, $T_a=25^{\circ}C$, $Z_S=Z_I=50\Omega$, with application circuit



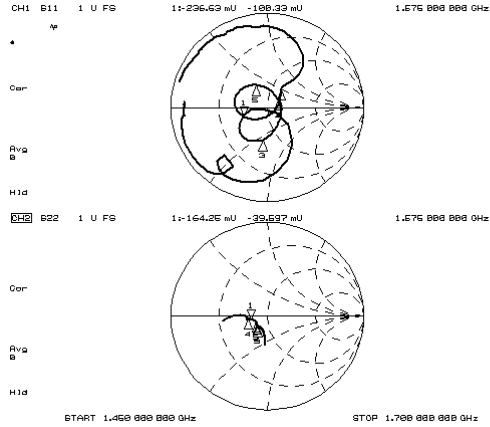
S11, S22



S21, S12



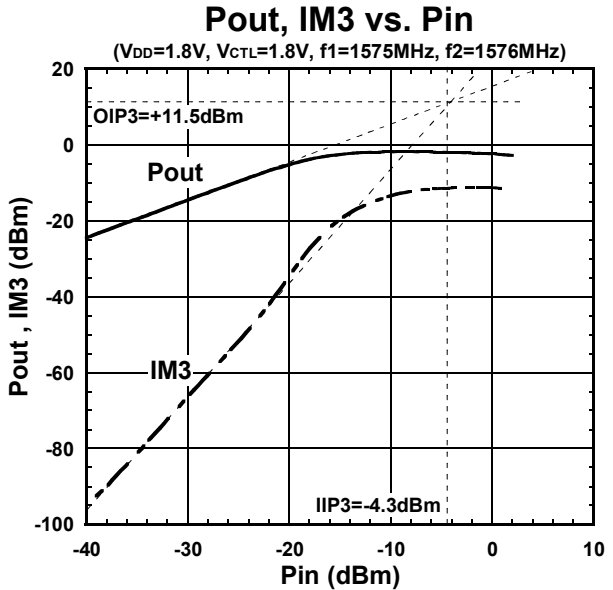
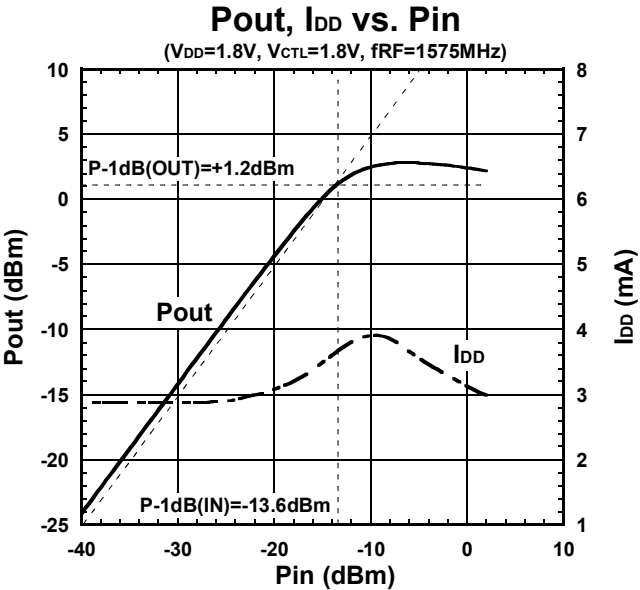
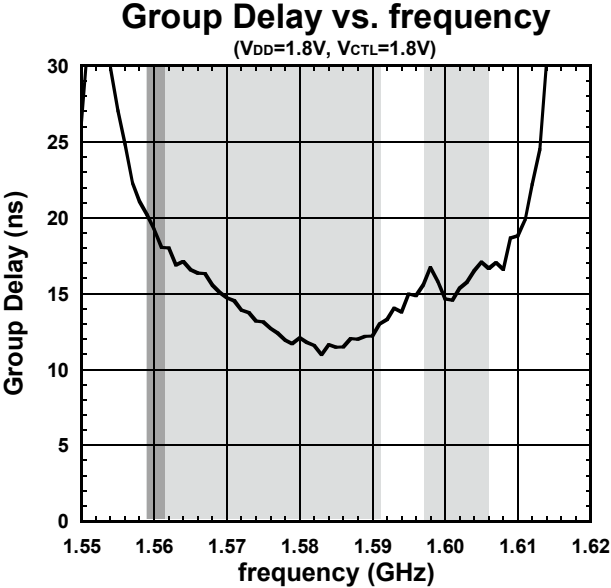
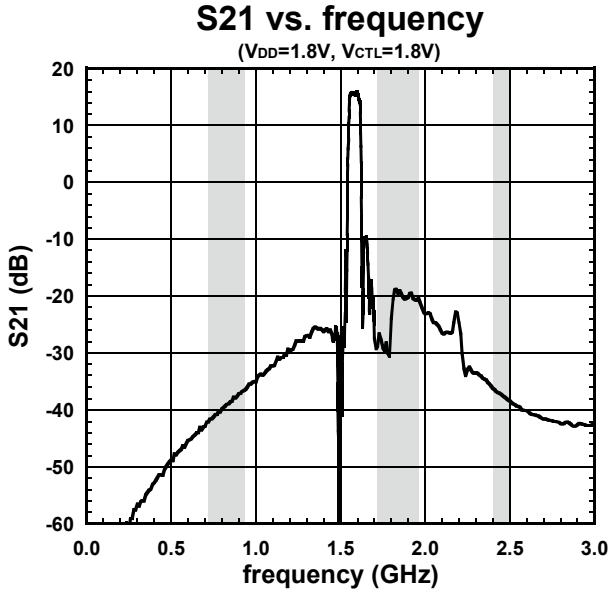
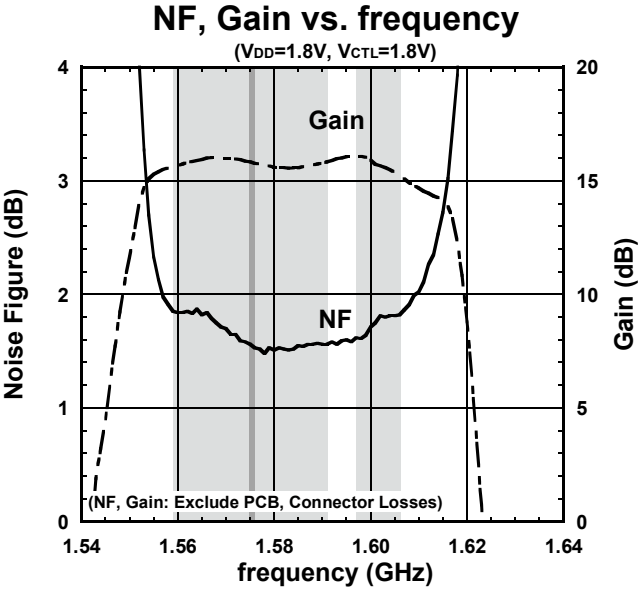
VSWR



Zin, Zout

ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=1.8V$, $V_{CTL}=1.8V$, $T_a=25^\circ C$, $Z_s=Z_l=50\Omega$, with application circuit

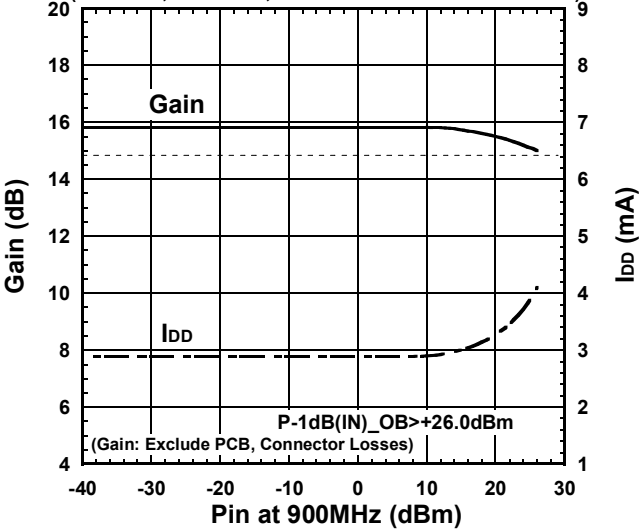


ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=1.8V$, $V_{CTL}=1.8V$, $T_a=25^\circ C$, $Z_s=Z_l=50\Omega$, with application circuit

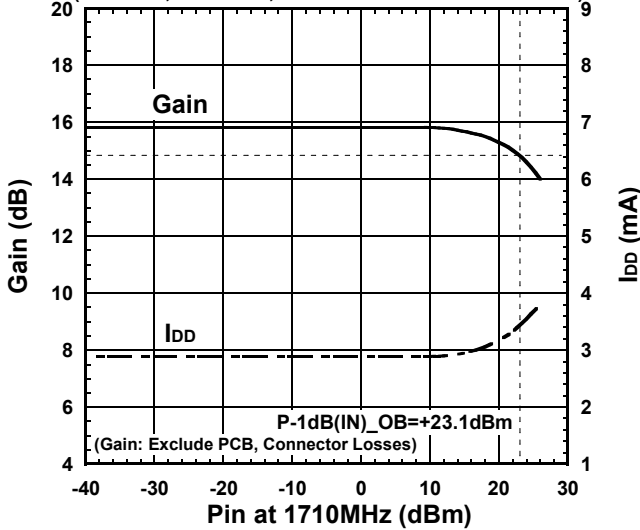
Out-of-band P-1dB (fjam=900MHz)

($V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575MHz$ at $Pin=-40dBm$)



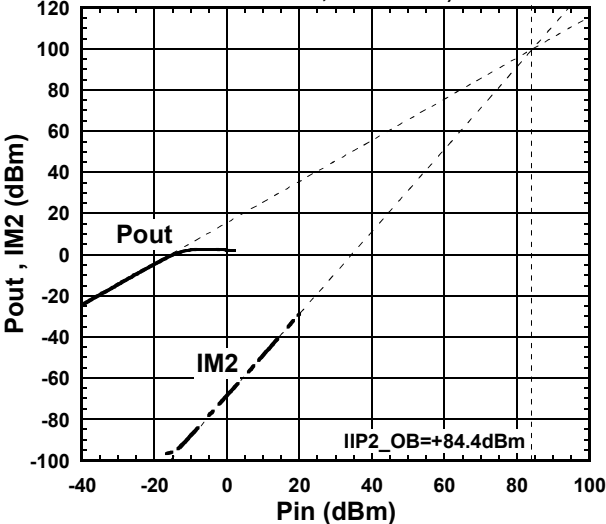
Out-of-band P-1dB (fjam=1710MHz)

($V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575MHz$ at $Pin=-40dBm$)



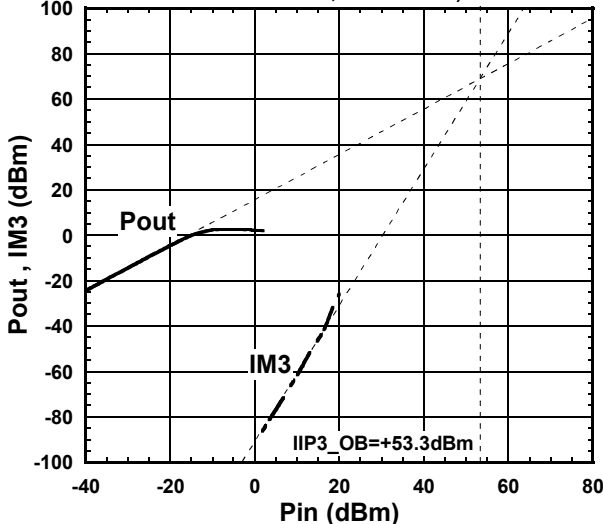
Out-of-band IIP2

($V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575.4MHz$, $f_1=824.6MHz$, $f_2=2400MHz$)



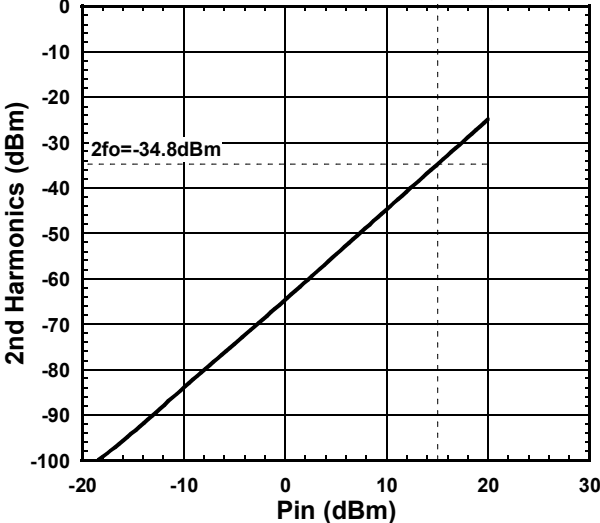
Out-of-band IIP3

($V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{meas}=1575.4MHz$, $f_1=1712.7MHz$, $f_2=1850MHz$)



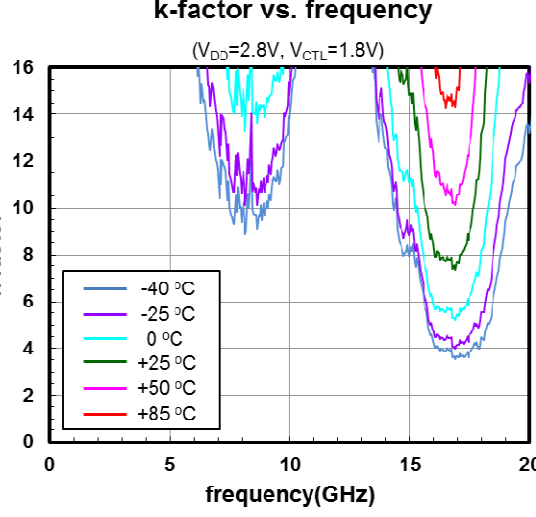
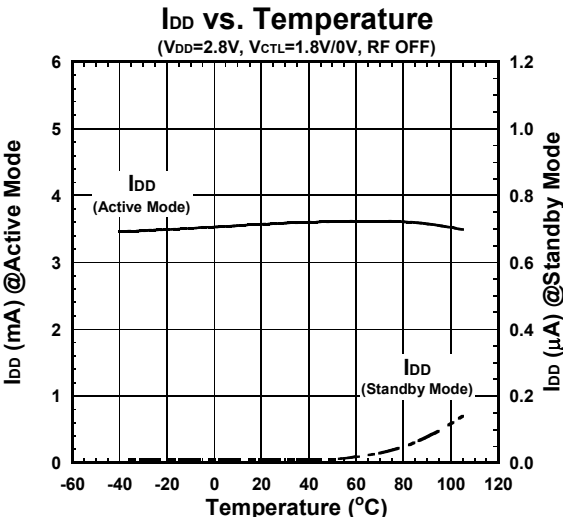
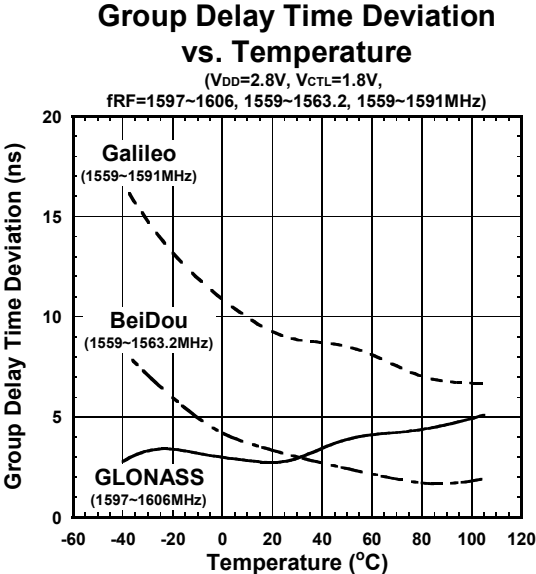
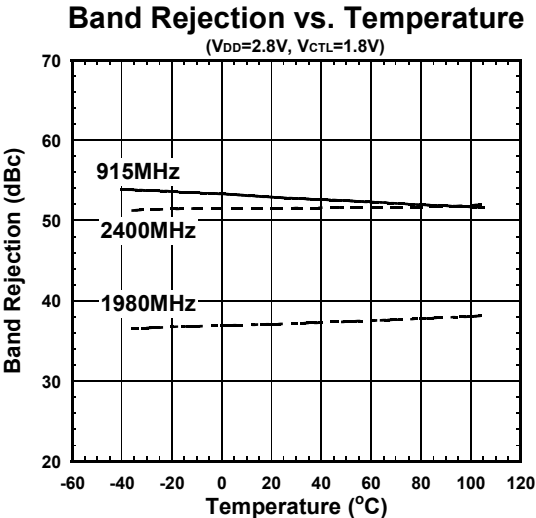
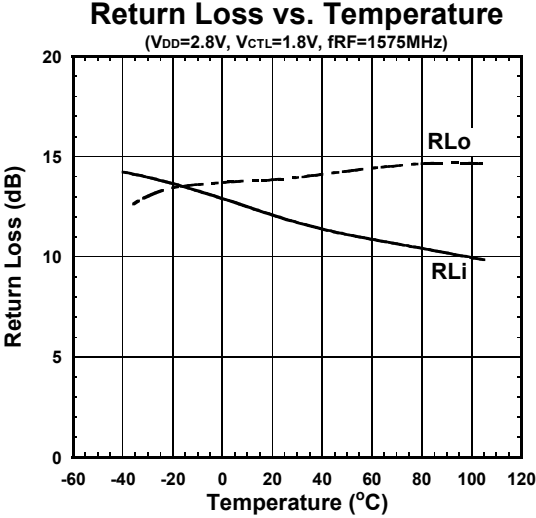
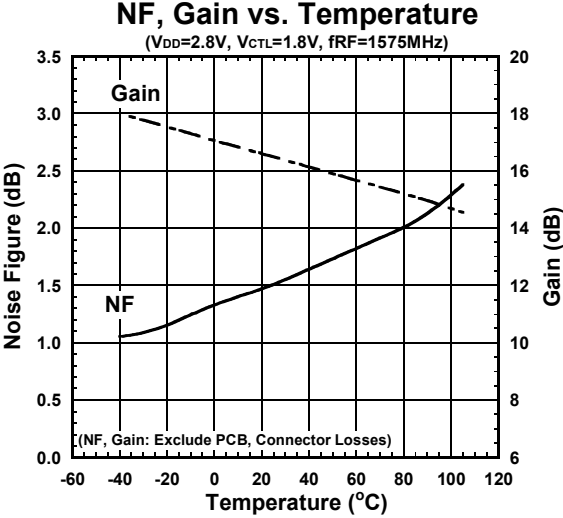
2nd Harmonics

($V_{DD}=1.8V$, $V_{CTL}=1.8V$, $f_{in}=787.76MHz$, $f_{meas}=1575.52MHz$)



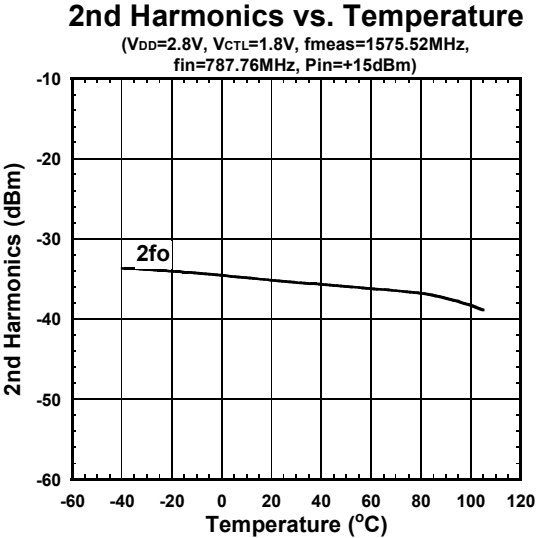
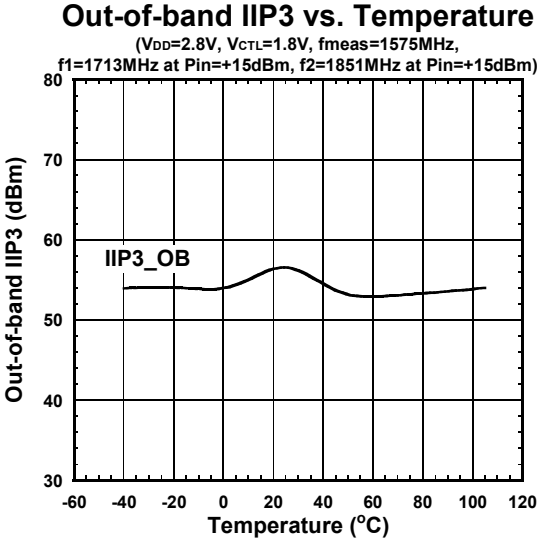
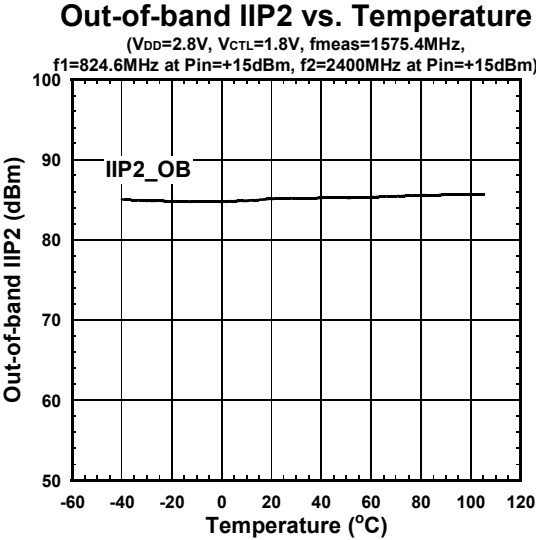
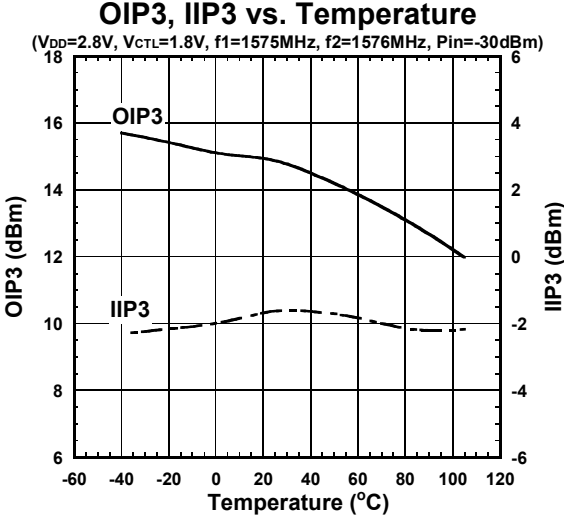
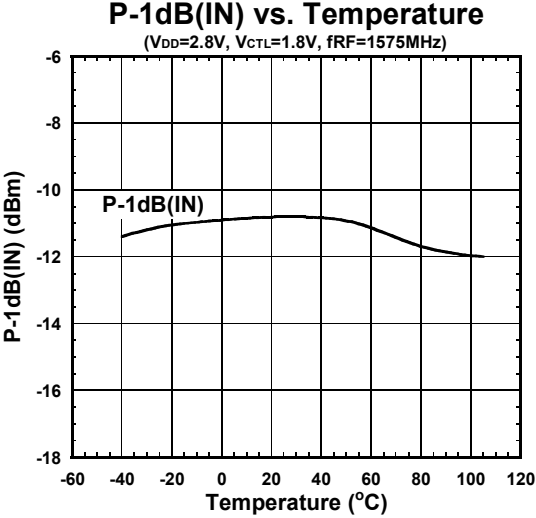
■ ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $Z_s=Z_l=50\Omega$, with application circuit



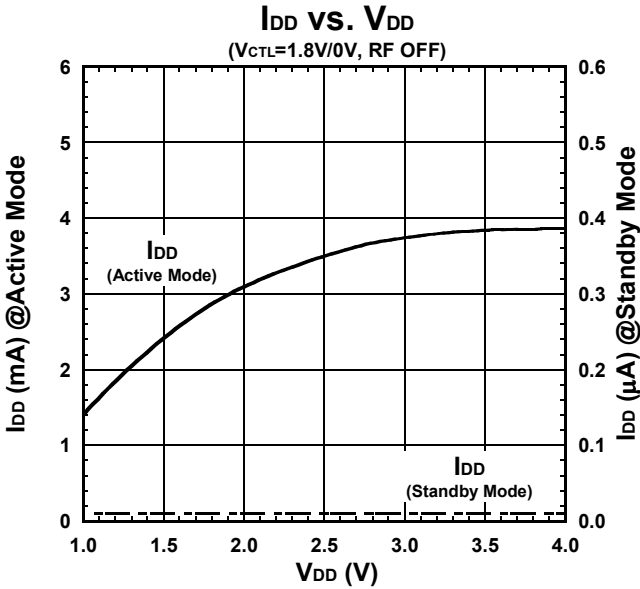
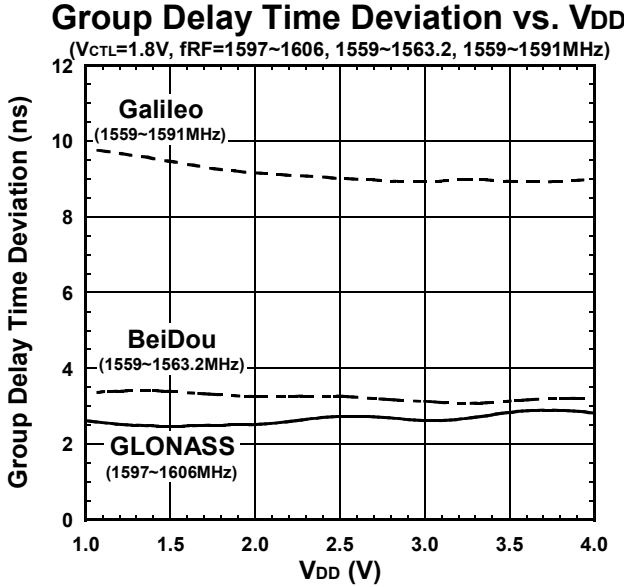
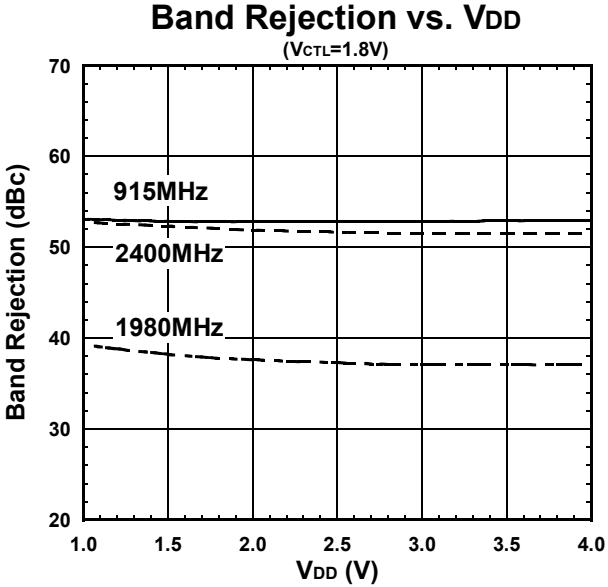
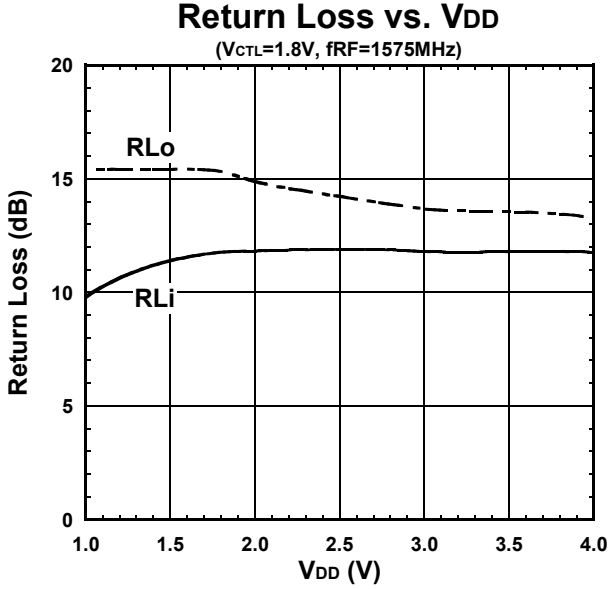
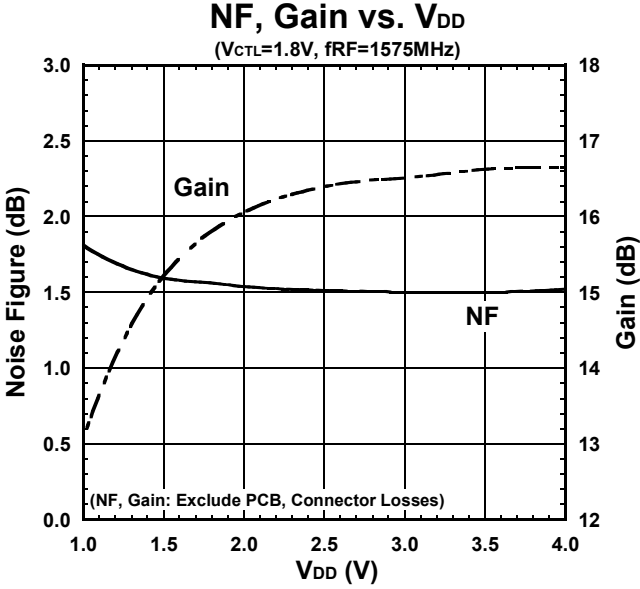
■ ELECTRICAL CHARACTERISTICS

Conditions: $V_{DD}=2.8V$, $V_{CTL}=1.8V$, $Z_s=Z_l=50\Omega$, with application circuit



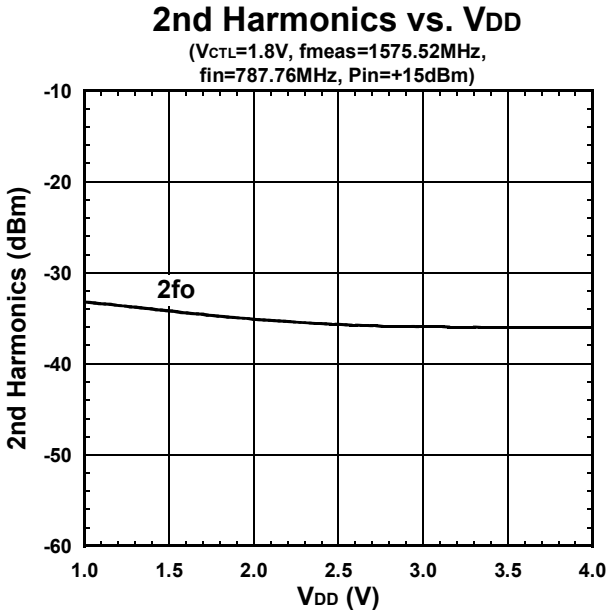
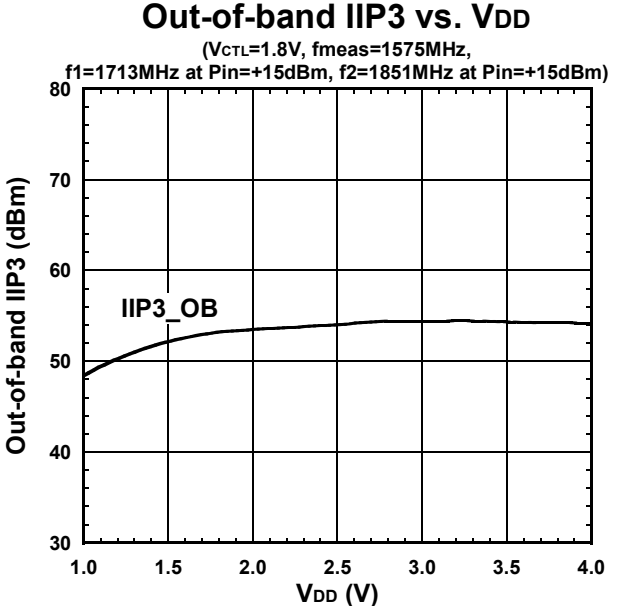
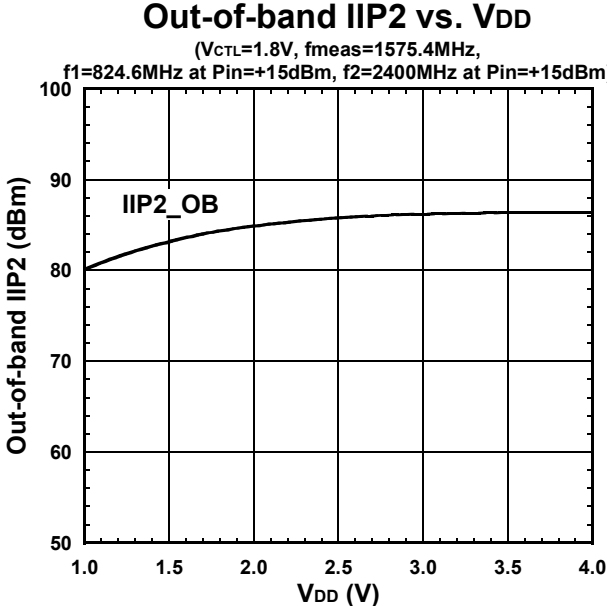
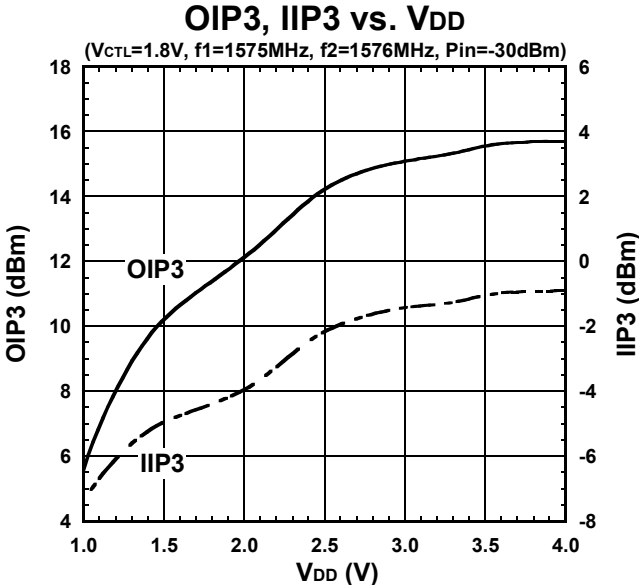
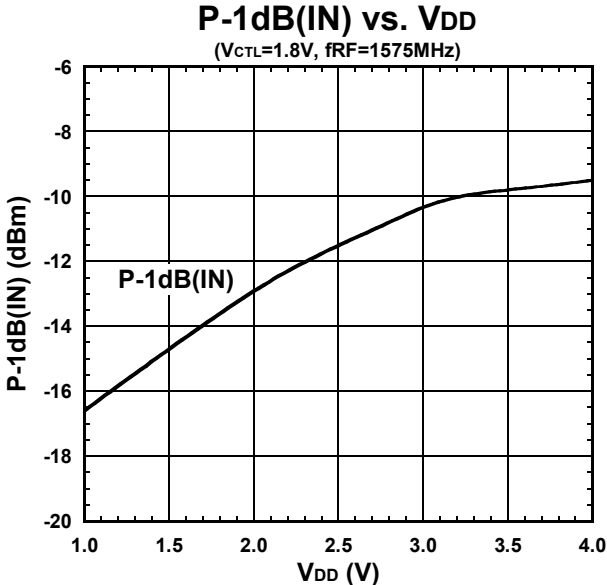
■ ELECTRICAL CHARACTERISTICS

Conditions: $V_{CTL}=1.8V$, $T_a=25^{\circ}C$, $Z_s=Z_l=50\Omega$, with application circuit

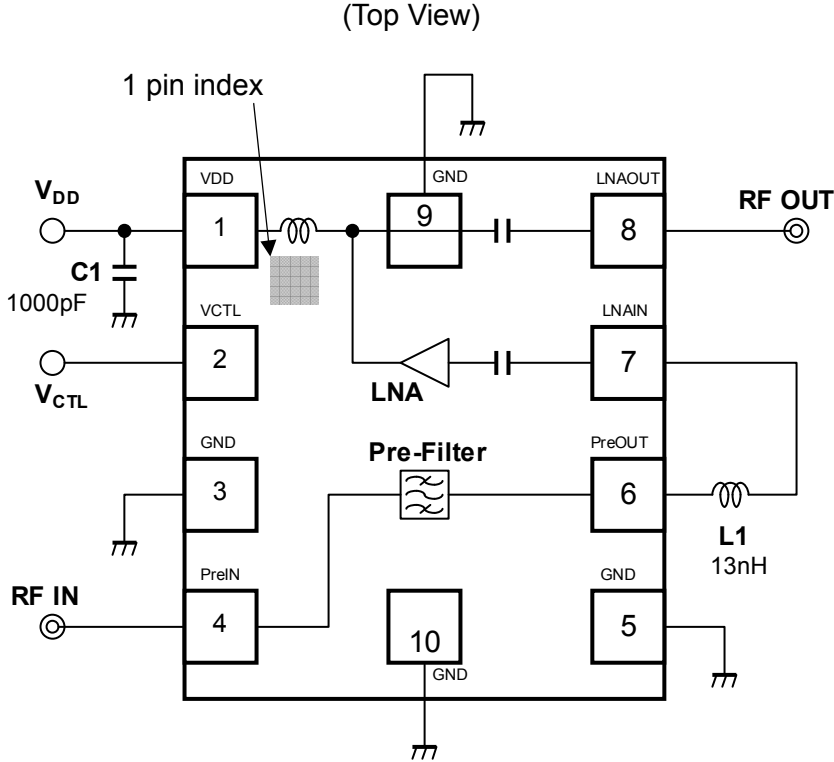


ELECTRICAL CHARACTERISTICS

Conditions: $V_{CTL}=1.8V$, $T_a=25^\circ C$, $Z_s=Z_l=50\Omega$, with application circuit



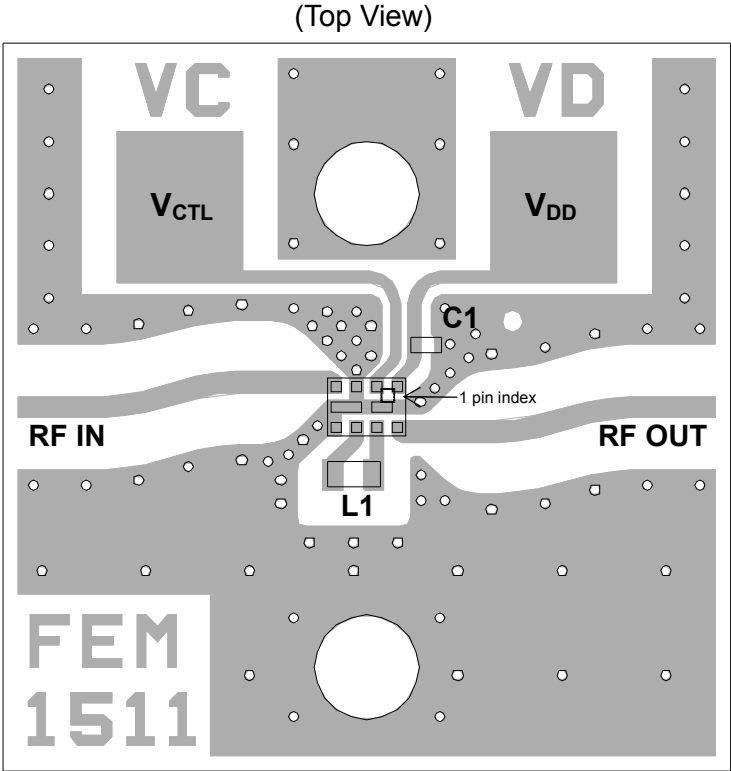
■ Application circuit



Parts list

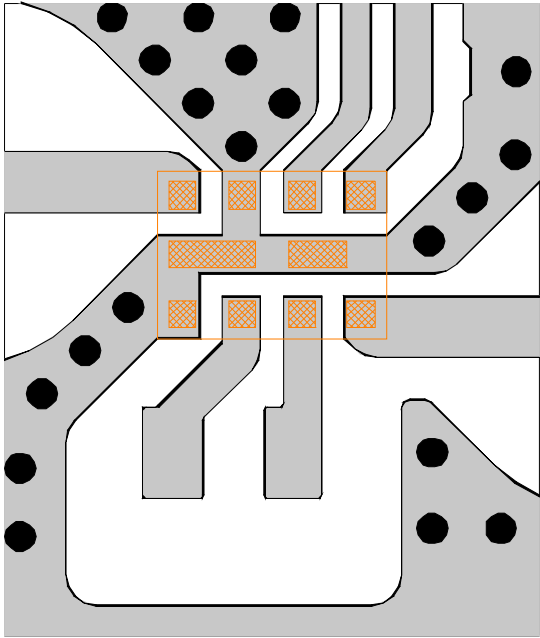
Parts ID	Manufacture
L1	LQW15AN_00 Series (MURATA)
C1	GRM03 Series (MURATA)

■ Evaluation board



PCB
 Substrate: FR-4
 Thickness: 0.2mm
 Microstrip line width: 0.4mm ($Z_0=50\Omega$)
 Size: 14.0mm x 14.0mm

<PCB LAYOUT GUIDELINE>






- PCB
- ▨ PKG Terminal
- PKG Outline
- GND Via Hole
Diameter $\phi= 0.2\text{mm}$

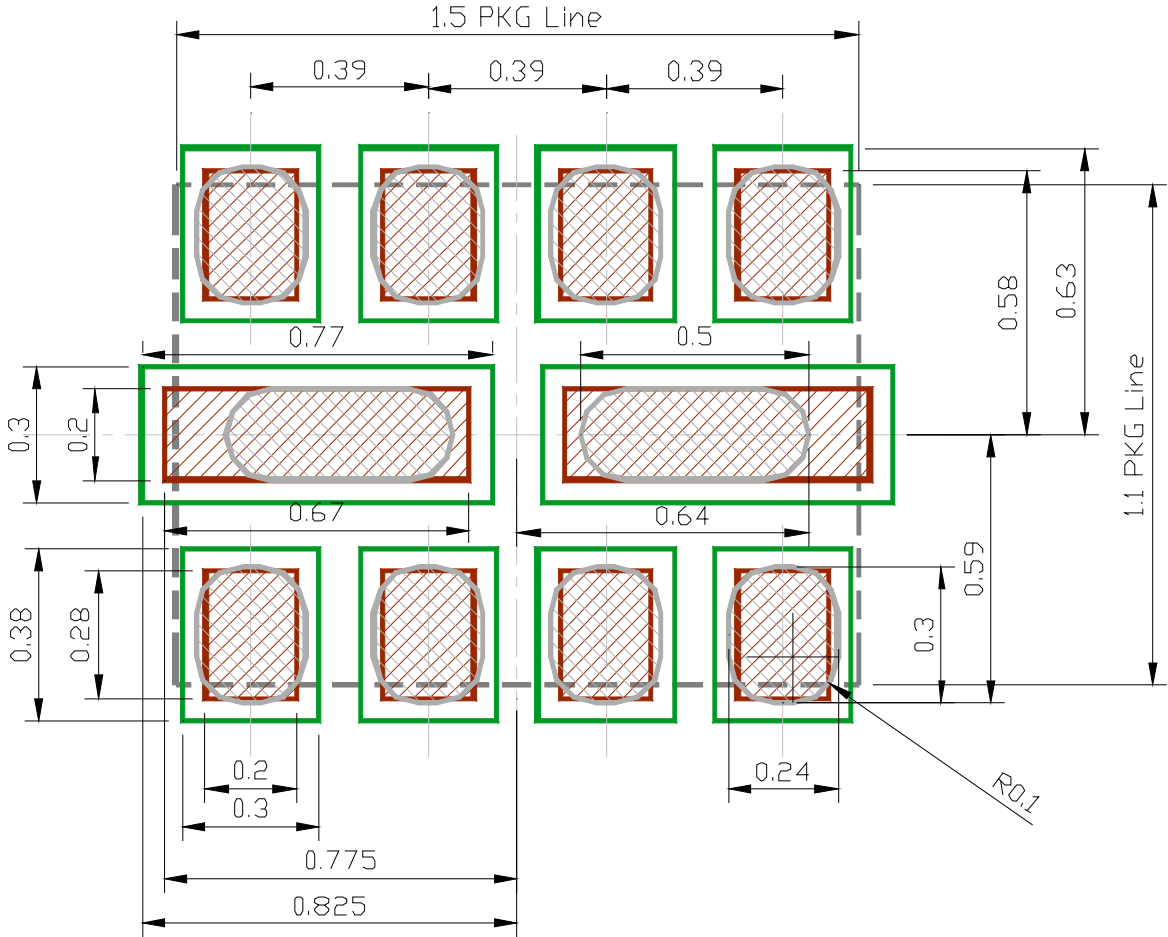
PRECAUTIONS

- Please layout ground pattern under this FEM in order not to couple with RFIN and RFOUT terminal.
- All external parts should be placed as close as possible to the FEM.
- For good RF performance, all GND terminals must be connected to PCB ground plane of substrate, and via-holes for GND should be placed near the FEM.

RECOMMENDED FOOTPRINT PATTERN (HFFP10-HH Package) <Reference>

PKG : 1.5mm x 1.1mm
Pin pitch : 0.39mm

-  : Land
-  : Mask (Open area) *Metal mask thickness : 100μm
-  : Resist(Open area)



■ NOISE FIGURE MEASUREMENT BLOCK DIAGRAM

Measuring instruments

NF Analyzer : Agilent N8973A
 Noise Source : Agilent 346A

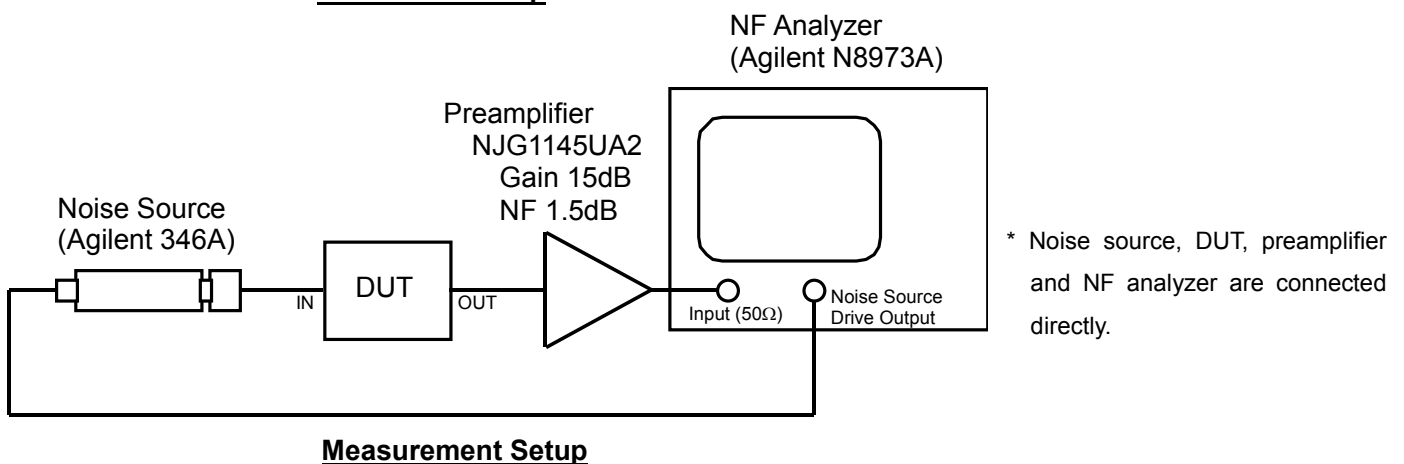
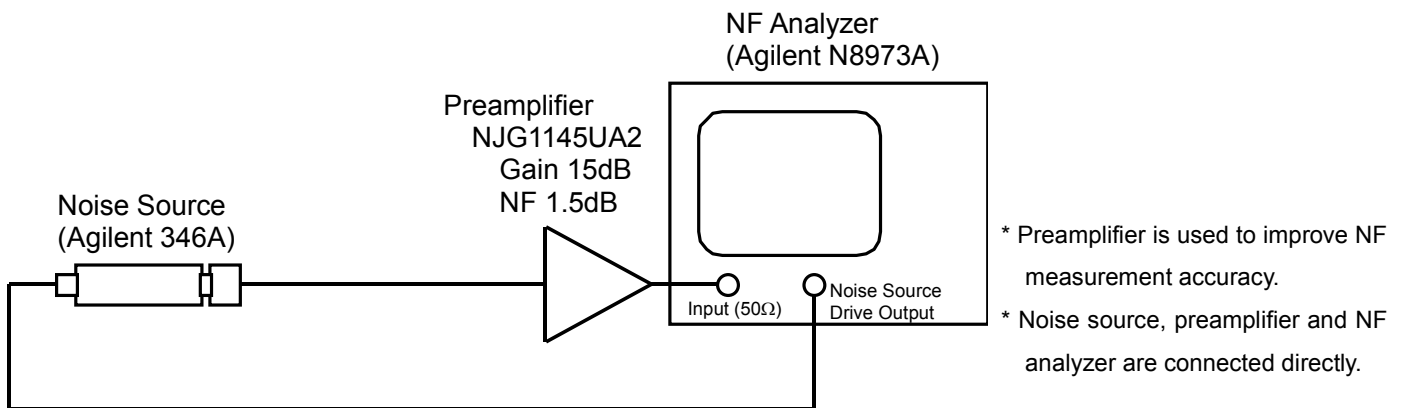
Setting the NF analyzer

Measurement mode form

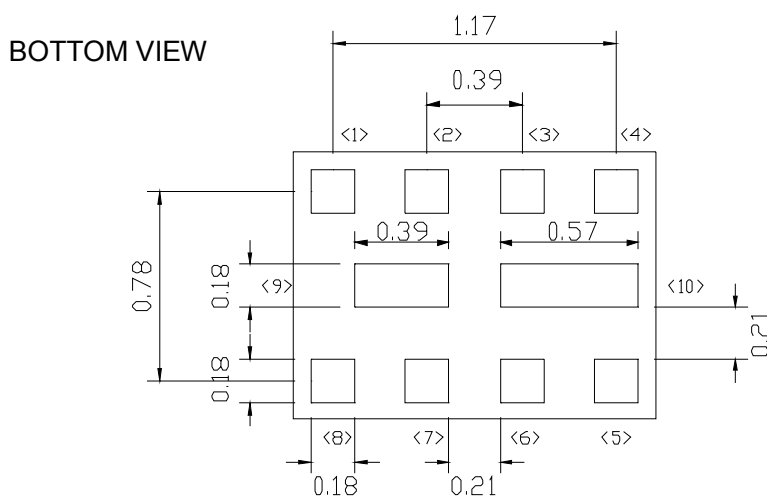
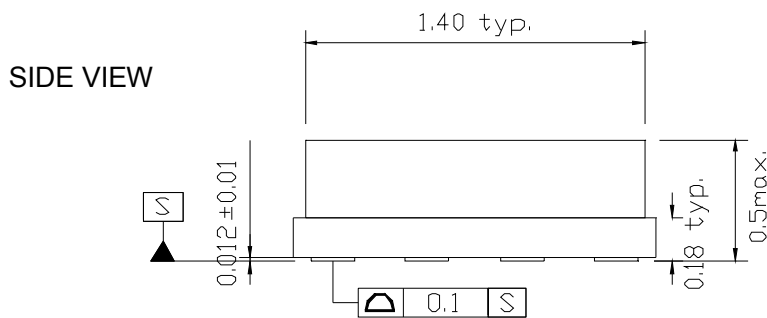
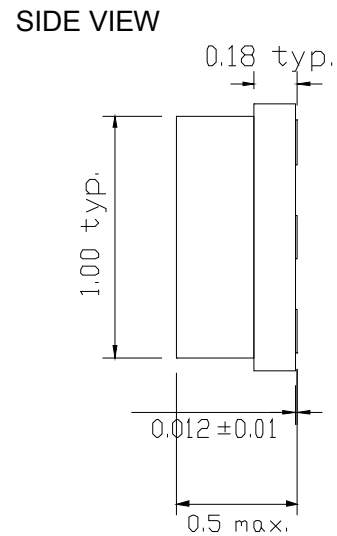
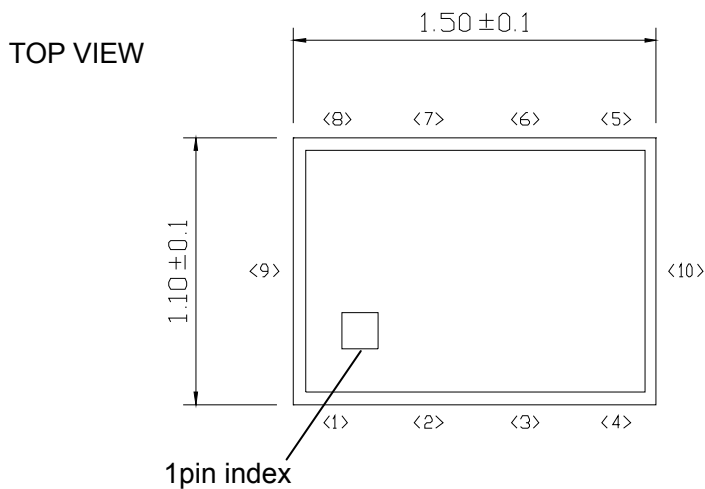
Device under test : Amplifier
 System downconverter : off

Mode setup form

Sideband : LSB
 Averages : 16
 Average mode : Point
 Bandwidth : 4MHz
 Loss comp : off
 Tcold : setting the temperature of noise source (303.15K)



Package outline (HFFP10-HH)



Electrode Dimensions clearance
: ±0.05mm

Unit : mm
Substrate : Ceramic
Terminal treat : Au
Lid : SnAg/Kovar/Ni
Weight (typ.) : 4.9mg

Cautions on using this product

This product contains Gallium-Arsenide (GaAs) which is a harmful material.

- Do NOT eat or put into mouth.
- Do NOT dispose in fire or break up this product.
- Do NOT chemically make gas or powder with this product.
- To waste this product, please obey the relating law of your country.

[CAUTION]

The specifications on this databook are only given for information, without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.

This product is hollow seal package type, and it is with the structure susceptible to stress from the outside. Therefore, note the following in relation to the contents, after conducting an evaluation, please use.

1. After mounting this product, to implement the potting and transfer molding, please the confirmation of resistance to temperature changes and shrinkage stress involved in the molding.
2. When mounted on the product, collet diameter please use more than 1mmφ. In addition, the value of static load is recommended mounting less than 5N.
3. For dynamic load at the time of mounting, please use it after confirming in consideration of the contact area / speed / load.